	U.S. DEPARTMENT OF COMME PATENT AND TRADEMARK OFF 19296 2. Name and address of receiving party(ies) Name: SUMCO CORPORATION Internal Address:		
To the Honorable Director of 1. Name of Conveying party(ies): Nobuyuki MORIMOTO Hideki NISHIHATA	2. Name and address of receiving party(ies) Name: SUMCO CORPORATION		
Name of Conveying party(ies): Nobuyuki MORIMOTO Hideki NISHIHATA	Name and address of receiving party(ies) Name: SUMCO CORPORATION		
Additional name(s) of conveying party(ies) attached?Yes _X_No	Internal Address:		
Additional name(s) of conveying party(ies) attached?Yes _X_No			
	Street Address: 2-1, Shibaura 1-chome, Minato-ku, Tokyo 105-8634 Ja		
3. Nature of conveyance: X Assignment Merger Security Agreement Change of Name			
Other	City: State: ZIP:		
Execution Date: January 31, 2006	Additional names(s) and address(es) attached?Yes _X_No		
Application number(s) or patent number(s):			
If this document is being filed together with a new application, the	e execution date of the application is: <u>January 31, 2006</u>		
A. Patent Application No.(s)	B. Patent No.(s)		
10570353			
Additional nu	umbers attached:Yes _X_No		
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved: _1		
Name: William S. Boshnick	7. Total Fee (37CFR 3.41) \$40.00		
Internal Address: P29118	X Enclosed		
	Authorized to be charged to deposit account		
·	Deposit account number:		
Street Address: GREENBLUM & BERNSTEIN, P.L.C.	19-0089		
1950 Roland Clarke Place	(Attach duplicate copy of this page if paying by deposit account)		
City: Reston State: VA ZIP: 20191			
	NOT USE THIS SPACE		

ASSIGNMENT

WHEREAS, Nobuyuki MORIMOTO, a citizen of Japan, whose post office address is c/o SUMCO CORPORATION, 2-1, Shibaura 1-chome, Minato-ku, Tokyo 105-8634 Japan, and Hideki NISHIHATA, a citizen of Japan, whose post office address is c/o SUMCO CORPORATION, 2-1, Shibaura 1-chome, Minato-ku, Tokyo 105-8634 Japan, hereinafter referred to as the ASSIGNORS, have invented a certain improvement relating to

Method for Producing SOI Wafer

for which they have executed, on the same date as this assignment, an application for Letters Patent for the United States to be filed in the United States Patent and Trademark Office, which Application is a National Stage of International Application No. PCT/JP2004/012822, filed September 3, 2004.

If this Assignment is filed after the filing date of the above-identified application, the undersigned hereby authorize and request any one of the attorneys of record in this application including Neil F. Greenblum, Reg. No. 28,394, Bruce H. Bernstein, Reg. No. 29,027, William Boshnick, Reg. No. 44,550, Arnold Turk, Reg. No. 33,094, James L. Rowland, Reg. No. 32,674, Stephen M. Roylance, Reg. No. 31,296, Leslie J. Paperner, Reg. No. 33,329, William Pieprz, Reg. No. 33,630, Robert W. Mueller, Reg. No. 35,043 and William E. Lyddane, Reg. No. 41,568, of the firm Greenblum & Bernstein, P.L.C., whose address is 1950 Roland Clarke Place, Reston, Virginia 20191, to insert here in parenthesis (Application No. ________, filed _______) the filing date and application number of said application when known.

AND WHEREAS, SUMCO CORPORATION, a corporation organized and existing under the laws of Japan, whose post-office address is 2-1, Shibaura 1-chome, Minato-ku, Tokyo 105-8634 Japan, hereinafter known as the ASSIGNEE, is desirous of acquiring the entire right, title and interest for the United States in and to said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues, and prolongations thereof.

NOW, THIS WITNESSETH that for and in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt whereof is hereby acknowledged, said ASSIGNORS hereby assign, sell and transfer to said ASSIGNEE, its assigns and legal representatives, the entire and exclusive right, title and interest in and to said invention and application, for the United States including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted therefor, said ASSIGNEE and its assigns and legal representatives to have, hold, exercise and enjoy the said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges, and advantages in any ways arising from or pertaining thereto, for and during the term or terms of any and

all such Letters Patent when granted, including any and all renewals, reissues, and prolongations thereof, for the use and benefit of said ASSIGNEE and its assigns and legal representatives in as ample and beneficial a manner to all intents and purposes as the said ASSIGNORS might or could have held and enjoyed the same, if this assignment had not been made.

AND said ASSIGNORS hereby agree to execute all papers necessary to file applications in the United States for said invention and to assign the same to said ASSIGNEE, or any assignee acquiring title to said invention, and to execute any other papers that may be needed in connection with filing said application and securing Letters Patent thereon.

AND said ASSIGNORS authorize and request the Commissioner of Patents to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said ASSIGNEE, its assigns and legal representatives, in accordance herewith.

IN TESTIMONY WHEREOF, this assignment is executed by said ASSIGNORS on the respective date indicated below.

First Witness:		
(Name)		
(Date)		
	Nobuyuki Morimoto Nobuyuki MORIMOTO	31/01/2008
Second Witness:	Nobuyuki MORIMOTO	Date
(Name)		
(Date)		

First Witness:			
(Name)	_		
(Date)		Statob An Objeto	31/01/2006
Second Witness:		Hideki NISHIHATA	Date
(Name)			
(Date)	<u> </u>		

RECORDED: 03/03/2006